

Art Unit: 1765 Examiner: Lan Vinh



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of:				þο	NO ENTER
Applicant	:	Toyokazu SAKATA)	·	LV
Serial No.	:	10/721,260)		A/ A/ol
Filed	:	November 26, 2003)	AMENDMENT AFTER FINAL	ı
For	:	ETCHING METHOD AND SEMICONDUCTOR DEVICE FABRICATING METHOD)	REJECTION	
Attorney Ref.	:	TAI 145) .	April 4, 2006	

Box AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of January 5, 2006, the period for reply to which has been set to expire on April 5, 2006.

A fee of \$ \(\) is being submitted concurrently. Should this remittance be accidentally missing, however, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.

=EE ENCLOSED:\$ Please charge any further iee to our ⊡sansit Account No. 18-0002